# MFBA2V2012

## Automotive multilayer chip ferrite bead



#### **Product features**

- · AEC-Q200
- Multilayer monolithic construction yields high reliability
- · 0805 (2012 metric) surface mount package
- · Ultra-low direct current resistance (DCR)
- · Impedance range: 30 ohms to 1000 ohms
- · Moisture sensitivity level (MSL): 1

#### **Applications**

- Body electronics (keyless entry, ECU, antennas)
- Advanced driver assistance systems (ADAS)
- Infotainment and cluster electronics
- Safety electronics systems
- WLAN, WiFi, Bluetooth
- Portable medical devices
- Inventory management equipment
- Displays/monitors
- IoT, remote monitoring
- Testing equipment
- Automation equipment
- Sensors

### **Environmental compliance** and general specifications

- Operating temperature range: -55 °C to +150 °C (ambient plus self-temperature rise)
- Storage temperature (component): -55 °C to +150 °C
- Solder reflow temperature:
  J-STD-020 (latest revision) compliant







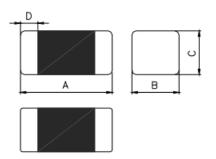


#### **Product specifications**

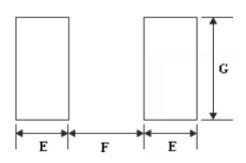
Part number²	Impedance (Ω) 100 MHz, ±25%, @ +25°C	DCR (Ω) maximum @ +25 °C	Rated current¹ (mA) maximum
MFBA2V2012-300-R	30	0.04	3000
MFBA2V2012-800-R	80	0.04	3000
MFBA2V2012-121-R	120	0.1	2000
MFBA2V2012-151-R	150	0.1	2000
MFBA2V2012-221-R	220	0.1	2000
MFBA2V2012-301-R	300	0.2	1000
MFBA2V2012-471-R	470	0.2	1000
MFBA2V2012-601-R	600	0.2	1000
MFBA2V2012-102-R	1000	0.15	1500
MFBA2V2012P-700-R	70	0.009	6000
MFBA2V2012P-111-R	110	0.013	5000
MFBA2V2012P-181-R	180	0.02	4000
MFBA2V2012P-331-R	330	0.04	2800
MFBA2V2012P-471-R	470	0.05	2500
MFBA2V2012P-601-R	600	0.06	2300

<sup>1.</sup> Rated current: DC current rating for an approximate self-temperature rise of 40 °C or less.

#### Mechanical parameters (mm)



#### Recommended pad layout



#### Schematic



Part number	Α	В	С	D	E (ref.)	F (ref.)	G (ref.)
MFBA2V2012(P)-xxx-R	2.0 ±0.20	1.25 ±0.20	0.85 ±0.20	0.50 ±0.30	1.05	1.00	1.45

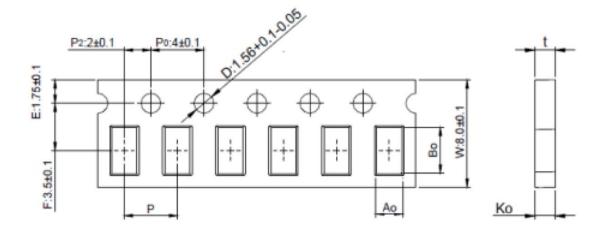
Part marking: No marking All soldering surfaces to be coplanar within 0.1 millimeters Tolerances are ±0.1 millimeters unless stated otherwise Pad layout dimensions are reference only Traces or vias underneath the inductor is not recommended

Part number definition: MFBA2V2012-xxx-R or MFBA2V2012P-xxx-R MFBA2V2012 = Product code and size MFBA2V2012P = Product code and size xxx = Impedance value in Ω, last character equals number of zeros -R suffix = RoHS compliant

#### Packaging information (mm)

Drawing not to scale

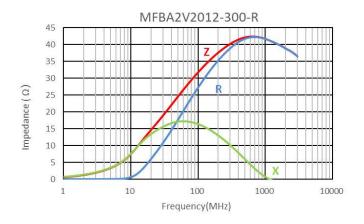
Supplied in tape and reel packaging, 4000 parts per 7" diameter reel (EIA-481 compliant)

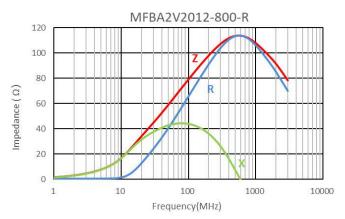


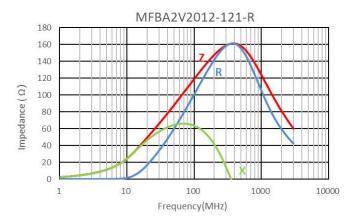
Во	$2.10 \pm 0.05$		
Ao	$1.30 \pm 0.05$		
Ко	$0.95 \pm 0.05$		
P	$4.0 \pm 0.10$		
t	0.95 ± 0.05	0.95 ± 0.05	

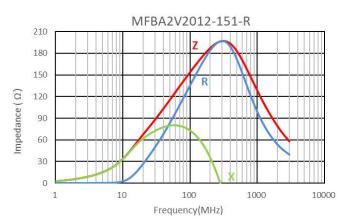
#### **Performance curves**

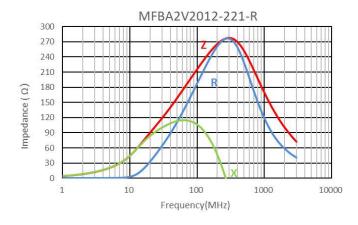
Z= impedance, R= resistance, X= reactance

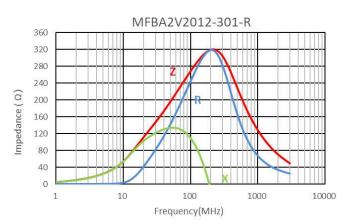






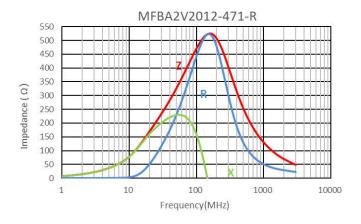


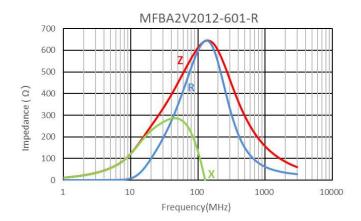


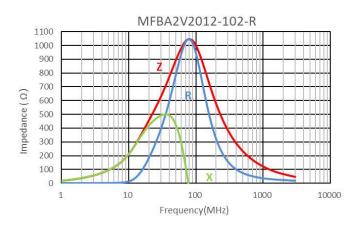


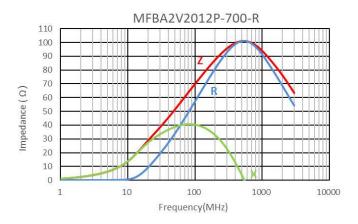
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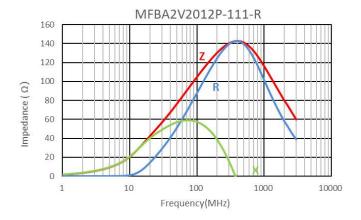
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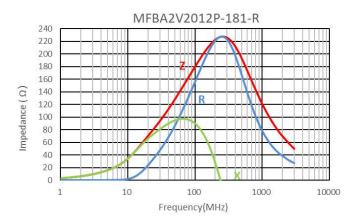






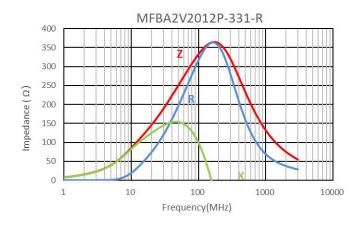


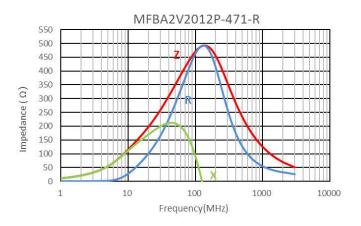


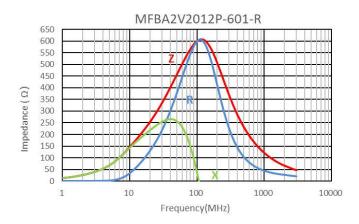


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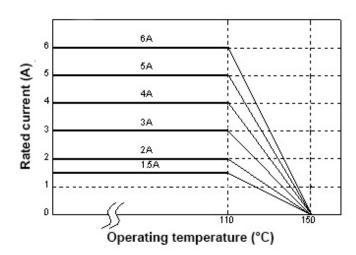
Z= impedance, R= resistance, X= reactance







#### **Derating curve**



#### Solder reflow profile

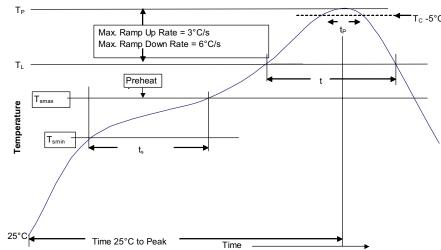


Table 1 - Standard SnPb solder ( $T_c$ )  $^{T_c-5^{\circ}C}$  Table 2 - Lead (Pb) free solder ( $T_C$ )

Package thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

#### Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T <sub>Smin</sub> )	100 °C	150 °C
• Temperature max. (T <sub>smax</sub> )	150 °C	200 °C
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 seconds	60-120 seconds
Ramp up rate T <sub>L</sub> to T <sub>p</sub>	3 °C/ second max.	3 °C/ second max.
Liquidous temperature ( $T_L$ ) Time ( $t_L$ ) maintained above $T_L$	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (T <sub>P</sub> )*	Table 1	Table 2
Time $(t_p)^*$ within 5 °C of the specified classification temperature $(T_c)$	20 seconds*	30 seconds*
Ramp-down rate (Tp to TL)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

 $<sup>^{\</sup>star}$  Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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